

#### **T-E5ZC** Bidirectional Micro Packaged TVS Diodes for ESD Protection

The T-E5ZC is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space comes at a premium.

This series has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD(electrostatic discharge), and EFT (electrical fast transients).

#### **Features**

- Peak Power Dissipation 100 W (8 x 20 us Waveform)
- Replacement for MLV (0603)
- Protects I/O Port
- Low Clamping Voltage
- Low Leakage
- Low Body Height: 1.68mg
- Response Time is < 1 ns
- Stand-off Voltage: 5.0 V
- **RoHS Compliant**
- Meets MSL 1 Requirements
- Solid-state silicon avalanche technology
- ROHS compliant
- Device Meets MSL 1 Requirements
- Tech chip technology

# **SOD-523**

#### Main applications

- Cellular handsets and accessories
- Portable instrumentation
- Peripherals
- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- Projection TV

#### Protection solution to meet

- IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)

Maximum ratings (Tamb=25 <sup>°</sup> C Unless Otherwise Specified)					
Parameter		Symbol	Value	Unit	
Peak Pulse Power (tp=8/20µs waveform)		P <sub>PPP</sub>	100	Watts	
ESD Rating per IEC61000-4-2:	Contact		30	KV	
	Air		30	ΚV	
Lead Soldering Temperature		T∟	260 (10 sec.)	${\mathbb C}$	
Operating Temperature Range		TJ	-55 ~ 150	${\mathbb C}$	
Storage Temperature Range		Тѕтс	-55 ~ 150	$^{\circ}$	
Lead Solder Temperature - Maximum (10 Second Duration)		T∟	260	$^{\circ}$	



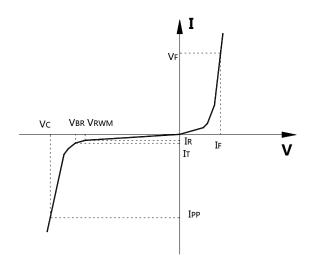


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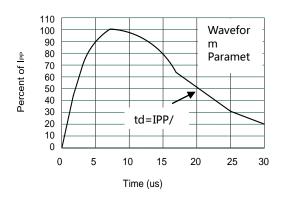
Electrical characteristics ( Tamb=25 <sup>°</sup> C Unless Otherwise Specified)						
Device VRWM (V)	VPWM	IR @ VRWM	VBR @ 1 mA	VC	Capacitance	
	VKVVIVI		(Volts)	@ 1 A	@ VR = 0 V, 1 MHz (pF)	
	(V)	(uA)	Min	(V)	Тур	Max
T-E5ZC	5.0	2	6.0	9.8	22	28

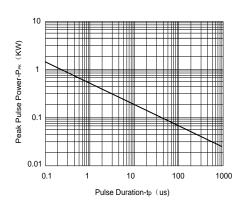
Junction capacitance is measured in VR=0V,F=1MHz

Symbol	Parameter		
VRWM	Working Peak Reverse Voltage		
V <sub>BR</sub>	Breakdown Voltage @ IT		
Vc	Clamping Voltage @ IPP		
I <sub>T</sub>	Test Current		
lгм	Leakage current at VRWM		
<b>I</b> PP	Peak pulse current		
Co	Off-state Capacitance		
CJ	Junction Capacitance		

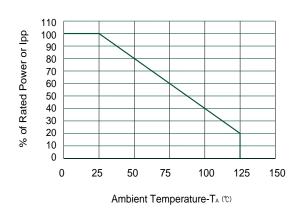


### Typical electrical characterist applications

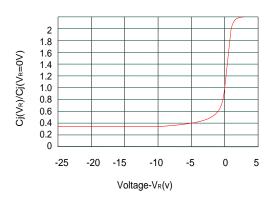




#### Pulse



#### Non-Repetitive Peak Pulse Power vs.



**Power Derating** 

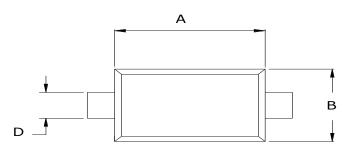
**Junction Capacitance vs. Reverse** 

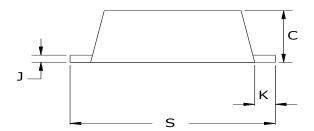


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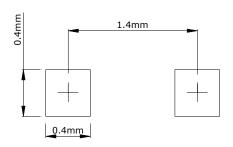
# **Package information**

# **SOD-523**





#### **Recommended Pad outline**



# **Ordering Information**

Device	Qty per Reel	Reel Size	
T-E5ZC	3000	7 Inch	

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.10	1.30	0.043	0.051
В	0.70	0.90	0.045	0.053
С	0.50	0.70	0.031	0.043
D	0.25	0.35	0.004	0.012
J	0.07	0.20	0.0028	0.0079
K	0.15	0.25	0.006	0.010
S	1.50	1.70	0.059	0.067